Width of 1.9mm contributes to thinner product designs and greater mounting efficiency





■ Typical Specifications

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10μA 1V DC
Initial contact resistance	500mΩ max.
Travel (mm)	0.12
Protective structure **	IP67 equivalent

Product Line

Product No.	Operating force	Operating direction	Operating life	Minimum order unit (pcs.)		
T TOUGGE NO.	Operating force	Operating direction	(5mA 5V DC)	Japan	Export	
SKSVCAE010	1.6N	Top push	300,000 cycles	20.000	20,000	
SKSVCCE010	2.2N	τορ μαστι	100,000 cycles	20,000		

Packing Specifications

Taping

Number of packages (pcs.)			Tape width	Export package	
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)	
20,000	200,000	200,000	12	401×401×214	

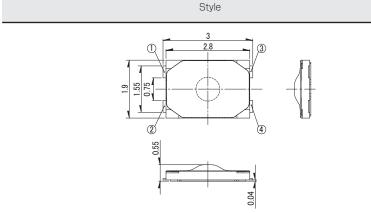
Reel size

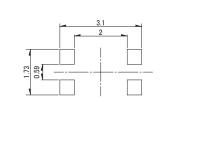
(Viewed from switch mounting face)

Note

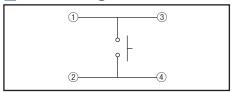
For reels of 330mm diameter, please inquire.

Dimensions PC board mounting hole and land dimensions





Circuit Arrangement



** Assumes the switch is left alone without being operated. Under the specified conditions, dust and water ingress with a significant impact on the switch's on-off function is prevented.

IP67 dust and water resistance is guaranteed for the switch alone and performance may not be guaranteed depending on the mounting conditions and usage.

Туре				Sharp Feeling Type					
	Туре			ı	Surface	Mount	1	1	
	Series	SKSD	SKRN	SKSV	SKSW	SKSF	SKSM	SKSG	SKRK
	Photo			0		0	•		•
	Features	Double	action		Compa Low-p			High operation force Compact size	Compact size Low-profile
	Water-proof	_	_	•	•	_	•	_	_
	Dust-proof	_	_	•	•	_	•	_	_
	IP standard	_	_	67 equivalency	67 equivalency	_	_	_	_
Operatir	Top push	•	•	•	•	•	•	•	•
directio	Side push	_	_	_	_	_	_	_	_
	W	4.1		2.8	3	2.8	3.4	3	3.9
Dimensio (mm)		3.9	□6	1.9	2	2.4	2.9	2.7	2.9
(11111)	Н	0.6	0.9	0.55	0.6	0.65	0.7	1.4	1.5/2
Operation force coverage	2N to 3N	See the rele for respect descri	ive product	1	\$	\$	\$	1	1
	Travel (mm)	See the releven respective produced		0.12	0.13	(D.1	0.12	0.13
G	round terminal	•	•	_	_	_	_	0	_
Operatin	ng temperature range	-40℃ t	o +90℃		_	-30°C to +85	îC .		-40℃ to +85℃
А	utomotive use	_	_	_	_	_	_	•	_
	Life Cycle	2	* 2	* 2	* 2	* 2	X 2	* 2	* 2
	Rating (max.) (Resistive load)		50mA 12V DC						
Electrical	Rating (min.) (Resistive load)				10μΑ	IV DC			
performance	Insulation resistance	100MΩ min. 100V DC 1min. 50MΩ min. 100MΩ min. 100V D			100V DC 1min.				
	Voltage proof				250V AC 1min.				
Durability	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively							
Dardonity	Lifetime	Shall be in accordance with individual specifications.							
	Cold	-40°C 96h							
Environmental performance	Dry heat	90°C 96h							
	Damp heat	60°C, 90 to 95%RH 96h							
	Page	217	218	219	220	221	222	223	225

W : Width. The most outer dimension excluding terminal portion. D : Depth. The most outer dimension excluding terminal portion.

Notes

H : Height. The minimum dimension if there are variances.

^{1.} The automotive operating temperature range to be individually discussed upon request.

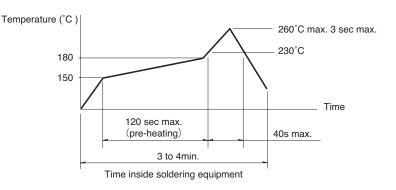
^{2.} Indicates applicability to all products in the series, while O indicates applicability to some products in the series.

TACT Switch™ Soldering Conditions

Condition for Reflow

Available for Surface Mount Type.

- 1. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at solder joints (copper foil surface).
 - A heat resistive tape should be used to fix thermocouple.
- 2. Temperature profile



Notes

- The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others.
 The above-stated conditions shall also apply to switch surface temperatures.
- Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH, SKPD Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKQJ, SKQK, SKEG Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

Manual Soldering

Items	Condition
Soldering temperature	350℃ max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH, SKHW, SKRG, SKPD Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ, SKQK, SKEG Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Notes

- 1. Prevent flux penetration from the top side of the TACT Switch™.
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA Corporation, or equivalents.)

